

145 Adams Avenue, Hauppauge, NY 11788 USA Tel: (631) 435-110 • Fax: (631) 435-1824 w w w . c e n t r a l s e m i . c o m mailto:processchange@centralsemi.com http://www.centralsemi.com/processchange PCN # 173 Notification Date: 11 June 2019

Product / Process Change Notice

Parts Affected:

The NPN power transistor wafer process, in a TO-126 Case.

Extent of Change:

The NPN power transistor chip has changed from 1.5mm x 1.5mm to 1.37mm x 1.37mm. See figures 1 and 2 for more information.

Reason for Change:

The NPN power transistor wafer has been modified in order to enhance the manufacturing process controls and performance. The wafer size has increased from 4 inch to 5 inch in order to improve throughput and leadtime.

Effect of Change:

The wafer process meets all electrical specifications of the individual device listed on the following page.

Qualification:

		P/N:	2N5192 Chip Process		Package:	TO-126	
No.		Test	Conditions (Reference standards are in bold)	Qty	Pass/Fail	Test Results	
1		Device Life Tests					
	а	Intermittent Operational Life (IOL)	3360 Cycles JESD22-A108	25	Pass	25/25	
	b	High Temperature Storage Life (HTSL)	T=150°C, t = 1000 hours JESD22-A103	25	Pass	25/25	
	с	Thermal Shock	1000 cycles, dwell time = 5 min, 0°C to +100°C, max transfer time = 20 sec. JESD22-A106	25	Pass	25/25	
	D	Temperature Cycling (TC)	-65°C -+150°C, Tdwell = 15min, 1000 cycles	77	Pass	77/77	
	E	High Temperature Reverse Bias (HTRB)	T=125°C, Tdwell = 15min, 1000 hours	25	Pass	25/25	



145 Adams Avenue, Hauppauge, NY 11788 USA Tel: (631) 435-1110 • Fax: (631) 435-1824 w w w . c e n t r a l s e m i . c o m mailto:processchange@centralsemi.com http://www.centralsemi.com/processchange PCN # 173 Notification Date: 11 June 2019

Effective Date of Change:

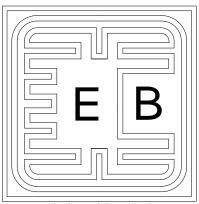
Existing inventory of the old process will be shipped until depleted.

Sample Availability:

Please contact your salesperson or manufacturer's representative for samples.

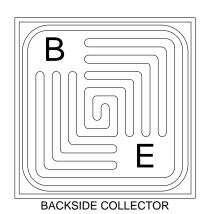
Figure 1: Old Chip Process

Size: 1.5mm x 1.5mm



BACKSIDE COLLECTOR

Figure 2: New Chip Process Size: 1.37mm x 1.37mm



Part Numbers Affected:

BD135	BD233
BD137	BD235
BD137-10	BD237
BD137-16	BD439
BD139	BD441
BD139-10	CEN925
BD139-16	MJE180
BD175	MJE181
BD177	MJE182
BD179	MJE221



145 Adams Avenue, Hauppauge, NY 11788 USA Tel: (631) 435-1110 • Fax: (631) 435-1824 w w w . c e n t r a l s e m i . c o m mailto:processchange@centralsemi.com http://www.centralsemi.com/processchange

PCN # 173 Notification Date: 11 June 2019

Part Numbers Affected:

MJE222	MJE521
MJE223	MJE720
MJE224	MJE721
MJE225	MJE722
MJE240	2N4921
MJE241	2N4922
MJE242	2N4923
MJE243	2N5190
MJE244	2N5191
MJE520	2N5192
	1



145 Adams Avenue, Hauppauge, NY 11788 USA Tel: (631) 435-1110 • Fax: (631) 435-1824 w w w . c e n t r a l s e m i . c o m mailto:processchange@centralsemi.com http://www.centralsemi.com/processchange PCN # 173 Notification Date: 11 June 2019

As per JEDEC standard JESD46, Customer Notification of Product/Process Changes by Solid-State Suppliers, a lack of acknowledgement of a PCN within thirty (30) days constitutes acceptance of the change.

The undersigned acknowledges and accepts Central Semiconductor's Product/Process Change Notification (PCN).

Company Name:	
Address:	
Printed Name:	
Title:	
Signature:	
Date:	